Resonator

Piezoelectric Resonator (4 to 20 MHz)

FAR Family (C3 series M/N type)

DESCRIPTION

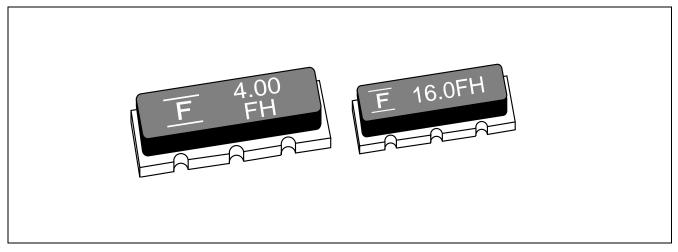
The features of the C3 series (M,N Type) resonators are compact and high stability. They are fabricated on a lithium tantalate (LitaO₃) substrate, producing resonators with ultra compact and superior stability due to the high electromechanical coupling coefficient of the material.

They include two loading capacitors inside and are housed in chip type of package for surface mount. These contribute saving mount space and reducing cost.

■ FEATURES

- High stability (Overall frequency deviation; 0.10% max)
- Ultra small package
- Wide frequency range in 4 MHz to 20 MHz
- Suitable for microcomputer clock
- · Emboss-typed pack for automatic mounting
- · Superior shock and vibration resistance, preventing damage during automatic mounting

PACKAGE



■ STANDARD CHARACTERISTICS

Series Item	C3 series	Remarks			
Material	Lithium Tantalate (LiTaO3)				
Frequency	4 MHz to 20 MHz				
Standard frequency	See "■ Standard Frequency."				
Initial frequency deviation	+0.025% -0.035% (F), ±0.05% (G)	$\pm 0.1\%$ (J) and \pm 0.3% (K) are also available upon request.			
Temperature characteristics	+0.035% –0.025% (Within –10°C to +60°C)	Reference temperature: +25°C			
Capacity of built-in capacitor	20 ±8 pF (Standard)	10 \pm 4 pF are also available. Capacity is specified by Fujitsu, considering matching data with applied IC (mainly microcomputer).			
Operating temperature	−30°C to +85°C				
Storage temperature	–40°C to +100°C				
Standard measuring circuit	 Oscillation frequency ¹ MΩ ¹ MΩ ¹ MΩ ¹ C₁ ^R ^R	Microcomputer 1/6MC74ACO4 × 2 (4 MHz to 8 MHz) 1/6TC74ACO4 × 2 (8 MHz to 20 MHz) • Vcc = 5.0 V DC • R: Resonator • C1, C2: Loading capacitors (built-in)			
	• Serial resonant resistance $ \begin{array}{c} $	R: Resonator Measuring equipment: Spectrum analyzer			

■ STANDARD FREQUENCY

Standard frequency (kHz)	Package size	Resonant resistance		
4,000 4,194	М	300 Ω max. (Symbol: 0)		
6,000 8,000 10,000 12,000 16,000 16,934 20,000	N	150 Ω max. (Symbol: 1)		

Notes: • Fujitsu can also develop another frequency device besides standard devices within 4 MHz to 20 MHz. • Regarding resonant resistance, maximum standard values are specified depending on frequency.

NOTES ON USE

- Handle carefully.
- Solder heat resistance.

5 seconds max. at +230°C (on PCB)

Recommended preheating is +150°C for one minute for avoiding giving extreme heat fluctuation to resonator. • Avoid using resonator under condition of extreme temperature fluctuation.

- There is no specific direction in resonator mounting.
- Oscillation data must be considered in case that this resonator is used as microcomputer clock.
- Resonator is designed for reflow solder, not for flow solder.

FAR Family (C3 series M/N type)

■ PART NUMBERING SYSTEM



(1) Series

Series	Material	Capacitators		
C3	LiTaO3	Built-in type		

(2) Package type

Symbol	Туре
С	Chip

(3) Package size

Symbol Size				
М	$4.5 \times 10.0 \times 2.0$ mm (4.0 MHz to 5.9 MHz)			
N	$3.2 \times 8.0 \times 1.6$ mm (6.0 MHz to 20.0 MHz)			

(4) Oscillation frequency

Frequency is specified with 5-digit in kHz of unit.

Frequency	Symbol
[Example] 8.000 MHz	08000

See "■ Standard Frequency."

(5) Initial frequency deviation

Symbol	Deviation
F	+0.025% -0.035%
G	±0.05%
J	±0.1%
К	±0.3%

(6) Built-in capacitors

Symbol	Capacitor			
0	20 ±8 pF			
1	10 ±4 pF			

(7) Resonant resistance

Symbol	Resistance
0	300 Ω max.
1	150 Ω max.

(8) Special mark

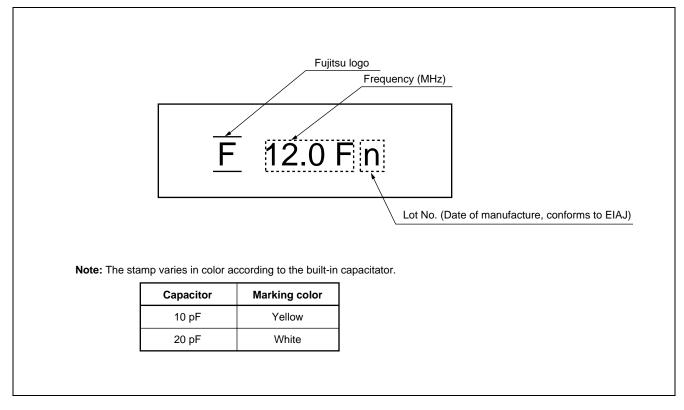
Symbol	Content Standard device, no taping specification			
Space				
—	Standard device, with Tape & Reel			
H to Z	Serial number for custom design			

(9) Taping specification

Symbol	Content
R	16 mm width emboss tape (3,000 pcs/reel)

FAR Family (C3 series M/N type)

■ MARKING

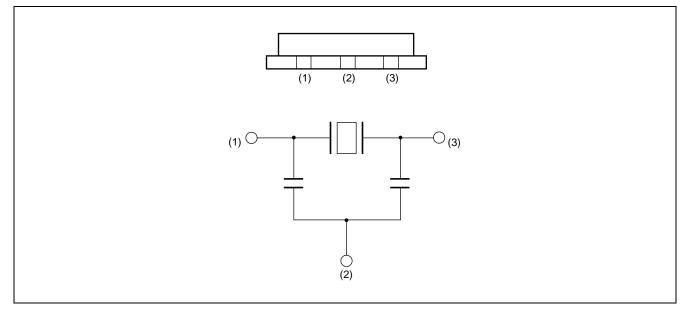


Data code (EIAJ standard) is specified as follows in four-year cycle.

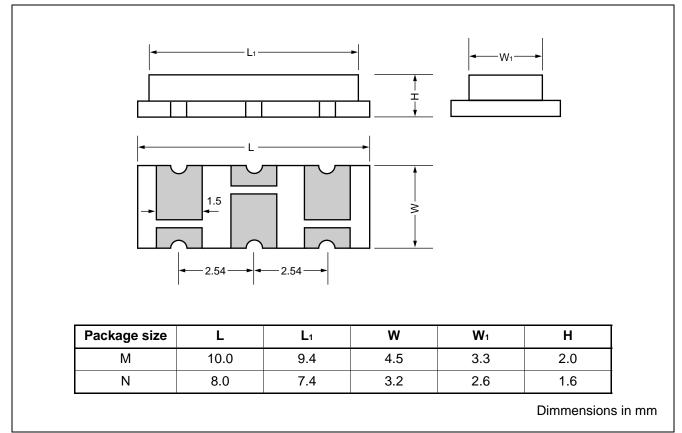
Year	Month	Mark									
	1	А	-	1	Ν	1999 2003	1	а	2000 2004	1	n
	2	В		2	Р		2	b		2	þ
	3	С		3	Q		3	c		3	8
	4	D		4	R		4	d		4	r
1997 2001	5	F	1998 2002	5	S		5	е		5	s
	6	G		6	Т		6	f		6	t
	7	Н		7	U		7	g		7	u
	8	I		8	V		8	h		8	u
	9	J		9	W		9	j		9	w
	10	К		10	Х		10	k		10	x
	11	L		11	Y		11	l		11	ų
	12	М		12	Z		12	m		12	3

FAR Family (C3 series M/N type)

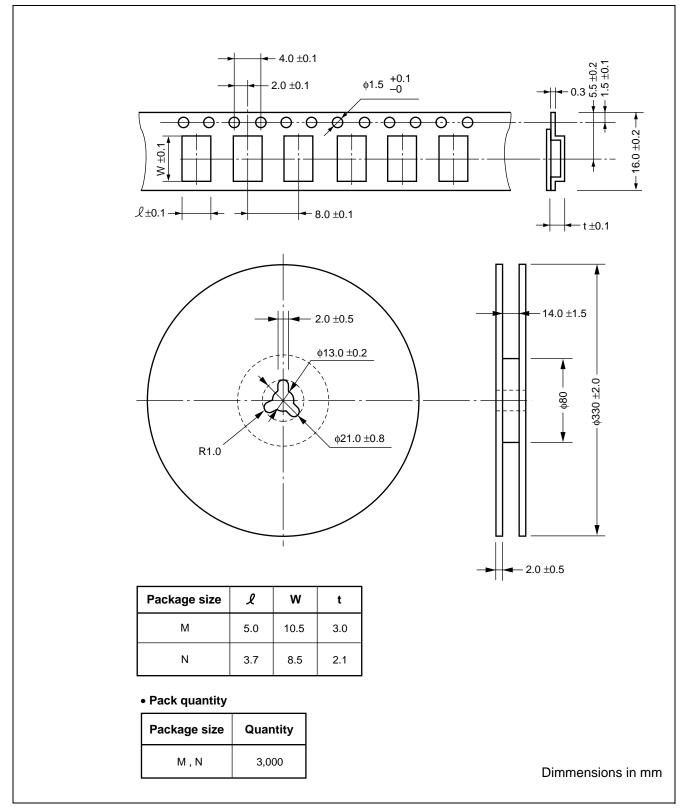
■ PIN ASSIGNMENT



■ DIMENSIONS



■ TAPING FORM AND DIMENSIONS



FUJITSU LIMITED

All Rights Reserved.

The contents of this document are subject to change without notice. Customers are advised to consult with FUJITSU sales representatives before ordering.

The information and circuit diagrams in this document are presented as examples of semiconductor device applications, and are not intended to be incorporated in devices for actual use. Also, FUJITSU is unable to assume responsibility for infringement of any patent rights or other rights of third parties arising from the use of this information or circuit diagrams.

The products described in this document are designed, developed and manufactured as contemplated for general use, including without limitation, ordinary industrial use, general office use, personal use, and household use, but are not designed, developed and manufactured as contemplated (1) for use accompanying fatal risks or dangers that, unless extremely high safety is secured, could have a serious effect to the public, and could lead directly to death, personal injury, severe physical damage or other loss (i.e., nuclear reaction control in nuclear facility, aircraft flight control, air traffic control, mass transport control, medical life support system, missile launch control in weapon system), or (2) for use requiring extremely high reliability (i.e., submersible repeater and artificial satellite).

Please note that Fujitsu will not be liable against you and/or any third party for any claims or damages arising in connection with above-mentioned uses of the products.

Any semiconductor devices have an inherent chance of failure. You must protect against injury, damage or loss from such failures by incorporating safety design measures into your facility and equipment such as redundancy, fire protection, and prevention of over-current levels and other abnormal operating conditions.

If any products described in this document represent goods or technologies subject to certain restrictions on export under the Foreign Exchange and Foreign Trade Law of Japan, the prior authorization by Japanese government will be required for export of those products from Japan.

F9801 © FUJITSU LIMITED Printed in Japan